

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
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CHIA YONG POO	08/28/2007
BOON SUAN JEUNG	08/28/2007
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DATE SIGNED:	03/30/2017
Total Attachments: 5	
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ASSIGNMENT

THIS ASSIGNMENT is by Eng Meow Koon, Chia Yong Poo, and Boon Suan Jeung, (the "Assignors"), residing at Block 249, #02-125, Pasir Ris Street 21, Republic of Singapore 510249, Block 37, #10-03, Bangkit Road, Republic of Singapore 679976; and 271-A Jin Kayu, Republic of Singapore 799499, respectively. We Assignors have invented one or more certain inventions (the "Invention(s)") described in a United States Patent Application entitled "MICROELECTRONIC DIE PACKAGES WITH METAL LEADS, INCLUDING METAL LEADS FOR STACKED DIE PACKAGES, AND ASSOCIATED SYSTEMS AND METHODS" (the "Application") and executed concurrently herewith.

Micron Technology, Inc., a corporation of the State of Delaware having a place of business at 8000 South Federal Way, P.O. Box 6, Boise, Idaho 83716-9632 ("Assignee"), desires to acquire the entire right, title and interest in and to the Invention(s) and the Application, and in and to any patents (collectively, "Patents") that may be granted for the Invention(s) in the United States or in any foreign countries.

For valuable consideration, the receipt and sufficiency of which we acknowledge, Assignors hereby sell, assign, and transfer to Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to: the Invention(s), the Application, and any Patents; any divisions, continuations, and continuations-in-part of the Application and any other application claiming priority rights from the Application; any reissues, reexaminations, or extensions of any and all Patents; the right to file foreign applications directly in the name of Assignee; and the right to claim priority rights deriving from the Application (collectively, the "Rights"). Assignors warrant that they are joint owners of the Rights, and that the Rights are unencumbered. Assignors also agree to not sign any writing or do any act conflicting with this assignment, and, without further compensation, sign all documents and do such additional acts as Assignee deems necessary or desirable to: perfect Assignee's enjoyment of the Rights; prepare and prosecute the Application or any other applications for Patents; conduct proceedings regarding the Rights, including any litigation or interference proceedings; or perfect or defend title to the Rights. Assignors request the Commissioner of Patents to issue any Patent of the United States that may be issued on the Invention(s) to Assignee. This Assignment may be executed in counterparts.

* * * * *

Date: 28 - Aug - 2007

Eng Meow Koon
Eng/Meow Koon

WITNESS TO SIGNATURE BY ENG MEOW KOON

_____	_____
Signature	Date

Print Name	


Street Address	

City, Country & Postal Code	

* * * * *

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Date: 28-Aug-2007


Chia Yong Poo

WITNESS TO SIGNATURE BY CHIA YONG POO

_____	_____
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City, Country & Postal Code	

* * * * *

Date: 28 Aug 2007



Boon Suan Jeung

WITNESS TO SIGNATURE BY BOON SUAN JEUNG

Signature

Date

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* * * * *

Date: 9/24/07



Russell D. Slifer
Chief Patent Counsel
MICRON TECHNOLOGY, INC.

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